

# **SDS2838** SWITCHING DIODE

# **Small Signal Fast Switching Diode**

#### **General Description**

Dual general-purpose switching diodes, fabricated in planar technology, and packaged in small SOT-23 surface mounted device (SMD) packages.

#### **Features and Benefits**

- Silicon epitaxial planar diode
- High switching speed: trr≤4ns
- · Low forward drop voltage and low leakage current
- "Green" device and RoHS compliant device
- Available in full lead (Pb)-free device





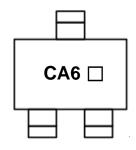
#### **Applications**

· Ultra high speed switching application

#### **Ordering Information**

Part Number	Marking Code	Package	Packaging
SDS2838	CA6 □	SOT-23	Tape & Reel

## **Marking Information**



CA6 = Specific Device Code

☐ = Year & Week Code Marking

#### **Pinning Information**

Pin	Description	Simplified Outline	Graphic Symbol
1	Anode (Diode 1)	3	
2	Anode (Diode 2)		**
3	Common Cathode	1 📙 📙 2	<del></del>

Rev. date: 25-AUG-10 KSD-D5C016-003 www.auk.co.kr

## **Absolute Maximum Ratings** (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Maximum repetitive peak reverse voltage	$V_{RM}$	85	V
Continuous reverse voltage	$V_R$	80	V
Maximum average forward rectified current	Io	100	mA
Forward current (DC)	I <sub>F</sub>	100	mA
Maximum repetitive peak forward current	I <sub>FM</sub>	300	mA
Non-repetitive peak forward surge current(t=10ms)	I <sub>FSM</sub>	2	А
Power dissipation 1)	P <sub>D</sub>	150	mW

<sup>&</sup>lt;sup>1)</sup> Device mounted on FR-4 board with recommended pad layout.

## Thermal Characteristics ( $T_{amb}$ =25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Thermal resistance, junction to ambient 1)	R <sub>th(j-a)</sub>	830	°C/W
Operating junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	-55 ~ 150	°C

<sup>1)</sup> Device mounted on FR-4 board with recommended pad layout.

# Electrical Characteristics (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Forward voltage <sup>2)</sup>	V <sub>F(1)</sub>	I <sub>F</sub> =1mA	1	0.6	-	V
	$V_{F(2)}$	I <sub>F</sub> =10mA	ı	0.7	-	V
	$V_{F(3)}$	I <sub>F</sub> =100mA	ı	0.9	1.2	V
Reverse leakage current 3)	$I_R$	V <sub>R</sub> =80V	ı	-	0.5	uA
Total capacitance	$C_{T}$	V <sub>R</sub> =0V, f=1 MHz	ı	2.2	4.0	pF
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> =10mA (Fig. 5)	-	1.6	4.0	ns

<sup>&</sup>lt;sup>2)</sup> Pulse test: t<sub>P</sub>≤380 µs, Duty cycle≤2%

<sup>&</sup>lt;sup>3)</sup> Pulse test:  $t_P \le 5 \text{ ms}$ , Duty cycle  $\le 2\%$ 

### **Rating and Characteristic Curves**

Fig. 1) Typical Forward Characteristics

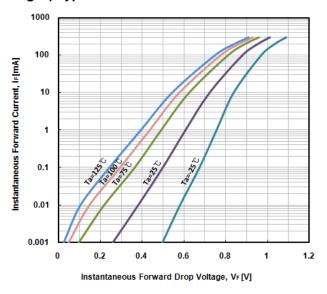


Fig. 2) Typical Reverse Characteristics

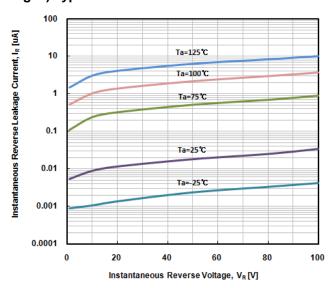


Fig. 3) Typical Total Capacitance Characteristics

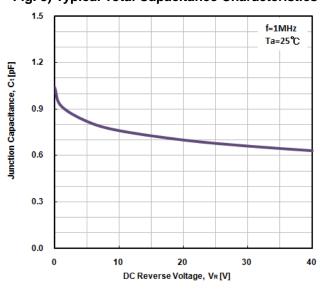


Fig. 4) Reverse Recovery Time vs. Forward Current

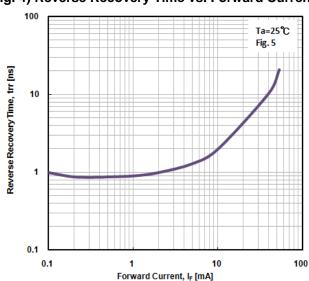
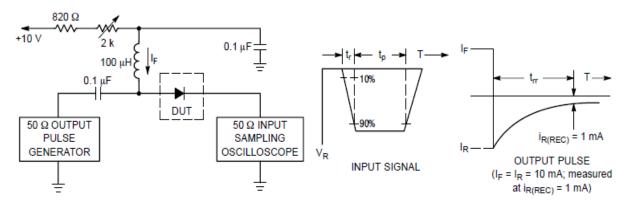
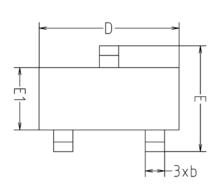
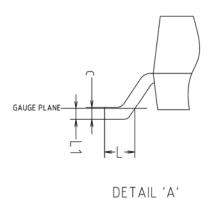


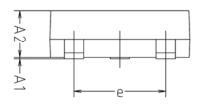
Fig. 5) Reverse recovery time equivalent test circuit

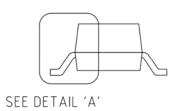


# **Package Outline Dimensions**



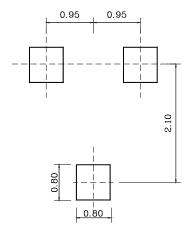






SYMBOL	MILLIMETERS			NOTE
STITIBUL	MINIMUM	NOMINAL	MAXIMUM	NOTE
A1	0.00	-	0.10	
A2	0.82	-	1.02	
Ь	0.39	0.42	0.45	
С	0.09	0.12	0.15	
D	2.80	2.90	3.00	
Е	2.20	2.40	2.60	
E1	1.20	1.30	1.40	
е	1.90BSC			
L	0.20	-	-	
L1	0.12BSC			

### **X** Recommend PCB solder land (Unit : mm)



**SDS2838** 

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